Posting Date: October 19, 2021

Closing Date: October 29, 2021 11:30 a.m. ET

Reference Number: 22-000546

To: NCI Bid Board

From: Tanya Proctor
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Subject: NCI Bid Board Posting – Service Agreement

The goal of the Molecular Imaging Branch (MIB) is to develop targeted imaging methods that accelerate the development of cancer therapies. The MIB is focused on the development and translation of *in vivo* molecular imaging agents for early detection, monitoring and therapy. Given the high risks and high costs of conducting research in this field, the MIB is well positioned to address the challenges that the field of molecular imaging faces. The Molecular Imaging Clinic conducts early phase trials of molecular imaging agents. MIB investigate diagnostic imaging agents that employ nuclear, optical or magnetic resonance reporters in human subjects.

The primary objective to renew a service contract for a government owned Leica BOND Rxm processing module.
The MIP needs to establish a service agreement, so service can be notified if the instrument is in need of repair.

The National Cancer Institute plans to purchase Service Agreement for Leica BOND Rxm Autostainer instrument, S/N: M494048 from Leica Microsystems. This is not a request for competitive quotation. However, if any interested party believes it can meet the attached requirements, it may submit a statement of capabilities. The capability statement must be in writing and must contain information and material in sufficient detail to allow NCI to determine is the party can fully meet this requirement. The capability statement must be received in the contracting office by 11:30 AM on October 19, 2021 ET. A determination by the Government not to compete this requirement based upon responses to this notice is solely within the discretion of the Government. Information received will be considered solely for the purpose of determining whether to conduct a competitive procurement.

Sole Source Justification:

The BOND Rxm staining module is manufactured and sold by Leica Microsystems. Leica distributes the BOND Rxm through Government Scientific Source, but not the service agreements. The repair requires personnel who are familiar with the instrument and have had training by Leica. Leica also does not sell their parts to third parties and if a vendor was able to be found, there would be a delay in repairing because the vendor would have to order the part from Leica. To find other vendors who also repair Leica instruments, a Google search was performed. No vendors appeared on the search. The MIB has had Leica as the service vendor since the instrument was initially purchased in 2017.

Attached Documents:
SF18
Statement of Work
FAR Clause 52.213-4 Simplified Acquisitions Terms and Conditions (JAN 2014) is applicable and available in full text upon request